IPC ASSOCIATION CO	Material Composition Decla © Copyright 2005. IPC, Bannockbur international and Pan-American copyright 2005.			claration urn, Illinois. All rights reserved under both pyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				rials and N	als and Mfg Information				
Supplier I	nformation														
Company na	me*	Company unique ID			ī	Unique ID Authority				Respon	Response Date*				
onsemi											2024-0	2024-05-02			
Contact Nam	ne		Title - Contact			]	Phone - Contact*				Email	Email - Contact*			
Product-Env	v-Stewards		Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
uthorized F	Representative*		Title - Representative			]	Phone - Representative*				Email	Email - Representative*			
Product-Env	v-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
R	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Da	ite Ver	Version Manufacturing Site			Weight*	UOM	Unit Type	
		LM317B	LM317BD2TG ANA 1.5A ADJU		ST OUT VRE	UT VREG 2024		02 MY1		MY1	909.21		mg	Each	
Manufactu	uring Proccess Informa	tion		,									·		
Te	Terminal Plating / Grid Array Material Te			erminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Tempera		dy Temperatu	ture Max Time at Peak Temper		ture Nur	mber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy			CU Alloy	1			260		C	30	seco	nds 3			
Comments															
evel 1 - maxi	imum time at peak temperati	are during sol	dering is 10-3	30 seconds											
or more inf	formation regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	es per the definition above except for selected exemp	otions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	astislav Drska	-6_									

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.19	mg	Supplier	Silicon (Si)	7440-21-3		0.19	mg
Die Attach	11.31	mg	A	Lead (Pb)	7439-92-1	7a	10.7445	mg
			Supplier	Tin (Sn)	7440-31-5		0.5655	mg
Lead Frame	340.51		Supplier	Iron (Fe)	7439-89-6		0.3405	mg
			Supplier	Copper (Cu)	7440-50-8		340.0674	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1022	mg
Mold Compound-Black	529.31			Epoxy resin	proprietary data		15.8793	mg
			Supplier	Phenolic Resin	Proprietary Data		7.9396	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		79.3965	mg
			Supplier	Carbon Black (C)	1333-86-4		2.6465	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		423.448	mg
Plating	27.15	mg	Supplier	Tin (Sn)	7440-31-5		27.15	mg
Wire Bond - Cu	0.74	mg	Supplier	Copper (Cu)	7440-50-8		0.74	mg